

L Number	Hits	Search Text	DB	Time stamp
-	6	tu-wen-chiang.in.	USPAT; US-PGPUB; EPO; JPO	2004/07/23 08:43
-	12	zhou-ren.in.	USPAT; US-PGPUB; EPO; JPO	2004/07/21 16:51
-	21	pham-xuyen.in.	USPAT; US-PGPUB; EPO; JPO	2004/07/21 16:53
-	466	451/60.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/07/23 15:04
-	194	(nozzle nozzles) same gas same (liquid slurry water cleaning) same (pad pads)	USPAT; US-PGPUB; EPO; JPO	2004/07/23 14:23
-	2	(nozzle nozzles) same atomize same (liquid slurry water cleaning) same (pad pads)	USPAT; US-PGPUB; EPO; JPO	2004/07/23 14:24
-	85	(nozzle nozzles) and ((pressure pressurized) with gas) and (slurry solution) and (water deionized DI) and (atomize atomizes atomization) and polishing	USPAT; US-PGPUB; EPO; JPO	2004/07/23 14:30
-	159	nozzles with manifold and (polishing CMP)	USPAT; US-PGPUB; EPO; JPO	2004/07/23 14:53
-	26	(nozzles with manifold and (polishing CMP)) and 451/\$.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/07/23 14:53
-	349	451/54.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/07/23 15:04
-	687	451/56.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/07/23 15:04
-	524	451/57.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/07/23 15:05
-	42	(451/54.ccls. 451/56.ccls. 451/57.ccls.) and manifold	USPAT; US-PGPUB; EPO; JPO	2004/07/23 15:05